SOOS016 D3115, APRIL 1988

- Compatible with TTL Inputs
- High-Speed Switching . . . 1 Mbit/s Typ
- Bandwidth . . . 2 MHz Typ
- High Common-Mode Transient Immunity . . . 1000 V/μs Typ
- High-Voltage Electrical Insulation . . . 3000 V DC Min
- Open-Collector Output
- UL Recognized . . . File Number 65085

### description

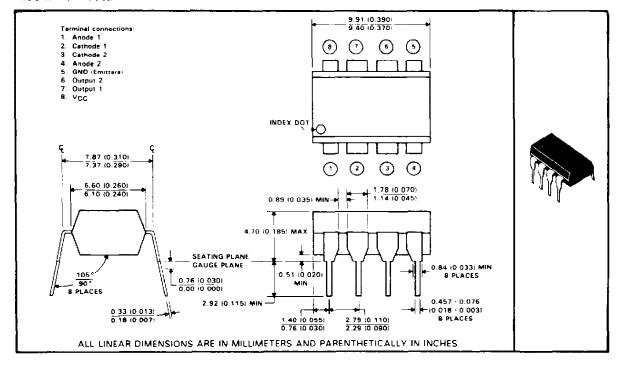
These high-speed optocouplers are designed for use in analog or digital interface applications that require high-voltage isolation between the input and output. Applications include line receivers that require high common-mode transient immunity, and analog or logic circuits that require input-to-output electrical isolation.

Each HCPL2530 and HCPL3531 optocoupler consists of two light-emitting diodes and two integrated photon detectors. Each detector is composed of a photodiode and an open-collector output transistor. Separate connections are provided for the photodiode bias and the transistor collector output. This feature, which reduces the transistor base-to-collector capacitance, results in speeds up to one hundred times that of a conventional phototransistor optocoupler.

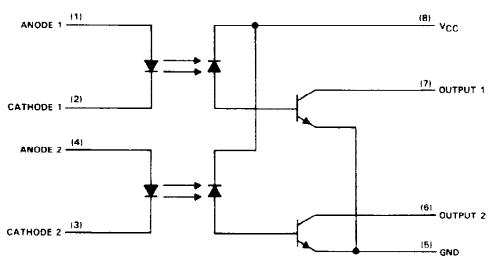
The HCPL2530 is designed for TTL/CMOS, TTL/LSTTL, and wide-band analog applications.

The HCPL2531 is designed for high-speed TTL/TTL applications.

### mechanical data



#### schematic



### absolute maximum ratings at 25 °C free-air temperature (unless otherwise noted)

Supply and output voltage range, VCC and VO
Reverse input voltage (each channel)
Peak input forward current (each channel) (pulse duration = 1 ms, 50% duty cycle, see Note 1) 50 mA
Peak transient input forward current (each channel) (pulse duration = 1 µs, f = 300 Hz) 1 A
Average forward input current (each channel) (see Note 2)
Peak output current (each channel)
Average output current (each channel)
Input power dissipation at (or below) 70°C free-air temperature
(each channel) (see Note 3)
Output power dissipation at (or below) 70°C free-air temperature
(each channel) (see Note 4)
Storage temperature range
Operating free-air temperature range
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds

- NOTES: 1. Denote linearly above 70 °C free-air temperature at the rate of 1.67 mA/°C.

  2. Denote linearly above 70 °C free-air temperature at the rate of 0.83 mA/°C.

  - 3. Derate linearly above 70 °C free-air temperature at the rate of 1.50 mW/ °C.
  - 4. Derate linearly above 70°C free-air temperature at the rate of 1.17 mW/°C.

# electrical characteristics over operating free-air temperature range of 0 $^{\circ}$ C to 70 $^{\circ}$ C (unless otherwise noted)

	046446770			HCPL2530			HCPL2531		
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP† MAX		UNIT
٧F	input forward voltage	IF = 16 mA, TA = 25°C		1.6	1.7		1.6	1.7	٧
VF	Temperature coefficient of forward voltage	IF = 16 mA		- 1.8	,		- 1.8		mV/°C
VBR	input breakdown voltage		5		-	5			V
VOL	Low-level output voltage	V <sub>CC</sub> = 4.5 V,   I <sub>OL</sub> = 1.1 mA		0.1	0.5				V
VOL	com-level output voltage	IF = 16 mA					0.1	0.5	<u> </u>
1	High-level	IF1 = IF2 = 00 VCC = VO1 = TA = 25°C VO2 = 5.5 V		3			3	500	пА
Юн	output current	V <sub>CC</sub> = V <sub>O1</sub> = V <sub>O2</sub> = 15 V,			50			50	μА
Іссн	Supply current, high-level output	$V_{CC} = 15 V$ , $I_{O1} = I_{O2} = 0$ , $I_{F1} = I_{F2} = 0$			4			4	μΑ
l a a	Supply current,	V <sub>CC</sub> = 15 V, I <sub>O1</sub> = 1 <sub>O2</sub> = 0,							
CCL	low-level output	IF1 = IF2 = 16 mA		BO		į	80		Δμ
CTR	Current transfer ratio	$V_{CC} = 4.5 \text{ V}, \qquad V_{O} = 0.5 \text{ V},$ $I_{F} = 16 \text{ mA}, \qquad T_{A} = 25 ^{\circ}\text{C},$ See Note 5	7%	18%		19%	24%		
СТЯ	Current transfer ratio	V <sub>CC</sub> = 4.5 V, V <sub>O</sub> = 0.5 V, I <sub>F</sub> = 16 mA, See Note 5	5%			15%			
'10	Input-output resistance	V <sub>IO</sub> = 500 V, T <sub>A</sub> = 25 °C, See Note 6		10 <sup>12</sup>			1012		Ω
lio.	Input-output insulation feakage current	V <sub>IQ</sub> = 3000 V, t = 5 s, T <sub>A</sub> = 25°C, RH = 45%, See Note 6			1			1	μΑ
C,	Input capacitance	V <sub>F</sub> = 0, f = 1 MHz	†	60			60		pF
Cio	Input-output capacitance	f = 1 MHz, See Note 6		0.6			0.6		pF
rii	Input-input resistance	V <sub>ii</sub> = 500 V, T <sub>A</sub> = 25 °C See Note 7		10 <sup>11</sup>			1011		Ω
1 <sub>ii</sub>	Input-input insulation leakage current	V <sub>ii</sub> = 500 V, t = 5 5, T <sub>A</sub> = 25°C, R <sub>h</sub> = 45%, See Note 7		0.005			0.005		μА
cii	Input-input capacitance	$f = 1 \text{ MHz}, \qquad T_A = 25^{\circ}\text{C},$ See Note 7		0.25			0.25		ρF

<sup>&</sup>lt;sup>†</sup>All typical values are at  $T_A = 25$  °C.

NOTES: 5. Current transfer ratio is defined as the ratio of output collector current to to the forward LED input current lp times 100%.

<sup>6.</sup> These parameters are measured between pins 2 and 3 shorted together and pins 5, 6, 7, and 8 shorted together.

<sup>7.</sup> These parameters are measured between pins 1 and 2 shorted together and pins 3 and 4 shorted together.

# operating characteristics at $V_{CC}$ = 5 V, $I_F$ = 16 mA, $T_A$ = 25 °C

PARAMÉTER		TEST CONDITIONS	HCPL2530			HCPL2531			UNIT
		TEST CONDITIONS	MIN TYP MAX MIN TYP MA			MAX			
BW	Bandwidth (-3 dB)	R <sub>L</sub> ≈ 100 Ω, See Note 8	2				2		MHz

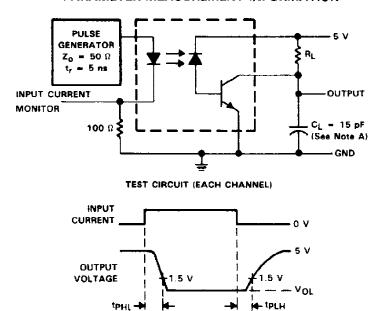
NOTE 7: Bandwidth is the range of frequencies within which the ac output voltage is not more than 3 dB below the low-frequency value.

# switching characteristics at VCC = 5 V, IF = 16 mA, TA = 25 °C (unless otherwise noted)

PARAMETER		TECT :	CANDITIONS	HCPL2530 MIN TYP MAX		HCPL2531				
		1531	CONDITIONS			MAX	MIN	TYP	MAX	UNIT
	Propagation delay time, low-to-high-level output	R <sub>L</sub> = 4.1 kΩ, See Figure 1	See Note 9,		1.0	1.5				
<sup>t</sup> PLH		R <sub>L</sub> = 1.9 kΩ, See Figure 1	See Note 10,		-			0.6	0.8	μS
_	Propagation delay time, high-to-low-level output	RL = 4.1 kΩ, See Figure 1	See Note 9,		0.7	1.5				
tPHL		R <sub>L</sub> = 1.9 kΩ, See Figure 1	See Note 10,					0.6	0.8	μS
d∨CM	Common-mode input  transient immunity, high-level output	ΔV <sub>CM</sub> = 10 V, R <sub>L</sub> = 4.1 kΩ, See Figure 2	*		1000					V/ ·
dt (H)		$\Delta V_{CM} = 10 \text{ V},$ $R_L = 1.9 \text{ k}\Omega,$ See Figure 2	IF = 0. See Notes 10 and 11,					1000		V/µs
d√CW (F)	Common-mode input ) transient immunity, low-level output	ΔV <sub>CM</sub> = 10 V, See Figure 2, See	$R_{\parallel} = 4.1 \text{ k}\Omega$ , e Notes 9 and 11,	-	1000					Vius
dt (L)		ΔV <sub>CM</sub> = 10 V, See Figure 2, See	R <sub>L</sub> = 1.9 kΩ, • Notes 10 and 11				-	1000		VIAS

- NOTES: 9. The 4.1-k $\Omega$  load represents one LSTTL unit load of 0.36 mA and a 6.1-k $\Omega$  pullup resistor.
  - 10. The 1.9-kΩ load represents one TTL unit load of 1.6 mA and a 5.6-kΩ pullup resistor.
  - 11. Common-mode transient immunity, high-level output, is the maximum rate of rise of the common-mode input voltage that does not cause the output voltage to drop below 2 V. Common-mode input transient immunity, low-level output, is the maximum rate of fall of the common-mode input voltage that does not cause the output voltage to rise above 0.8 V.

### PARAMETER MEASUREMENT INFORMATION

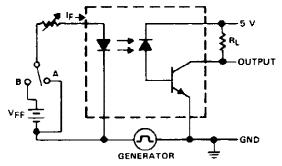


NOTE A:  $C_L$  includes probe and stray capacitance.

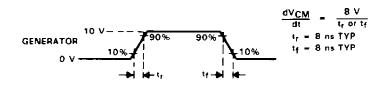
FIGURE 1. SWITCHING TEST CIRCUIT AND WAVEFORMS

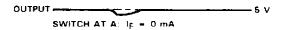
WAVEFORMS

### PARAMETER MEASUREMENT INFORMATION



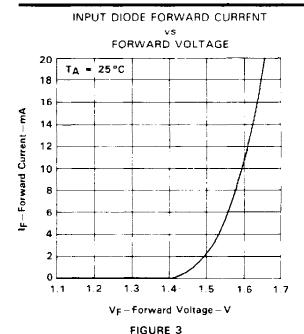
TEST CIRCUIT (EACH CHANNEL)

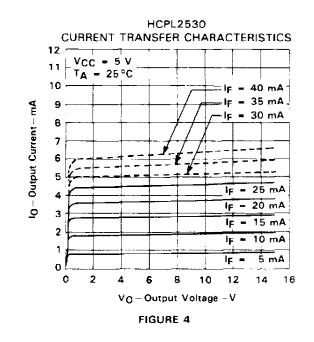


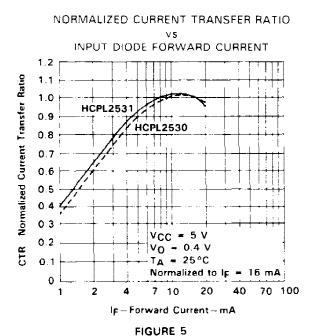


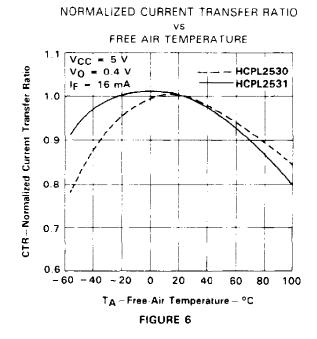
VOLTAGE WAVEFORMS

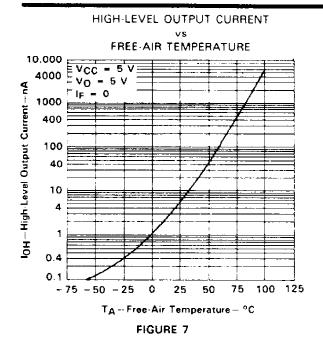
FIGURE 2. TRANSIENT IMMUNITY TEST CIRCUIT AND WAVEFORMS

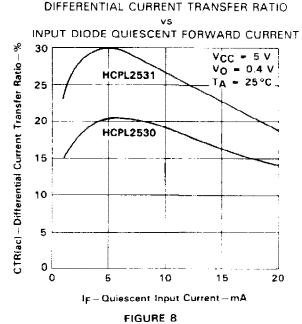


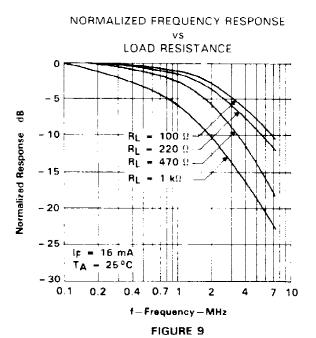


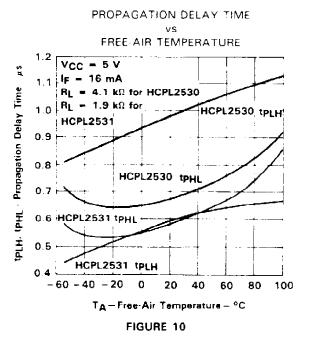












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